## MAC4DHM

## Preferred Device

## Sensitive Gate Triacs

## Silicon Bidirectional Thyristors

Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

## Features

- Small Size Surface Mount DPAK Package
- Passivated Die for Reliability and Uniformity
- Four-Quadrant Triggering
- Blocking Voltage to 600 V
- On-State Current Rating of 4.0 A RMS at $93^{\circ} \mathrm{C}$
- Low Level Triggering and Holding Characteristics
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V

Machine Model, C > 400 V

- Pb-Free Packages are Available

MAXIMUM RATINGS $\left(\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Peak Repetitive Off-State Voltage (Note 1) ( $\mathrm{T}_{\mathrm{J}}=-40$ to $110^{\circ} \mathrm{C}$, Sine Wave, 50 to 60 Hz , Gate Open) | $\mathrm{V}_{\mathrm{DRM}}$, <br> $V_{\text {RRM }}$ | 600 | V |
| On-State RMS Current <br> (Full Cycle Sine Wave, $60 \mathrm{~Hz}, \mathrm{~T}_{\mathrm{C}}=93^{\circ} \mathrm{C}$ ) | $\mathrm{I}_{\text {(RMS }}$ | 4.0 | A |
| Peak Non-Repetitive Surge Current (One Full Cycle, $60 \mathrm{~Hz}, \mathrm{~T}_{\mathrm{J}}=110^{\circ} \mathrm{C}$ ) | ITSM | 40 | A |
| Circuit Fusing Consideration ( $\mathrm{t}=8.3 \mathrm{msec}$ ) | 12 t | 6.6 | $\mathrm{A}^{2} \mathrm{sec}$ |
| Peak Gate Power <br> (Pulse Width $\leq 10 \mu \mathrm{sec}, \mathrm{T}_{\mathrm{C}}=93^{\circ} \mathrm{C}$ ) | PGM | 0.5 | W |
| Average Gate Power $\left(\mathrm{t}=8.3 \mathrm{msec}, \mathrm{~T}_{\mathrm{C}}=93^{\circ} \mathrm{C}\right)$ | $\mathrm{P}_{\mathrm{G}(\mathrm{AV})}$ | 0.1 | W |
| Peak Gate Current <br> (Pulse Width $\leq 10 \mu \mathrm{sec}, \mathrm{T}_{\mathrm{C}}=93^{\circ} \mathrm{C}$ ) | $\mathrm{I}_{\mathrm{GM}}$ | 0.2 | A |
| Peak Gate Voltage <br> (Pulse Width $\leq 10 \mu \mathrm{sec}, \mathrm{T}_{\mathrm{C}}=93^{\circ} \mathrm{C}$ ) | $\mathrm{V}_{\mathrm{GM}}$ | 5.0 | V |
| Operating Junction Temperature Range | $\mathrm{T}_{J}$ | -40 to 110 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. $V_{\text {DRM }}$ and $\mathrm{V}_{\text {RRM }}$ for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the device are exceeded.

## ON Semiconductor ${ }^{\circledR}$

http://onsemi.com

## TRIACS <br> 4.0 AMPERES RMS 600 VOLTS

MT2


ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

## MAC4DHM

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, - Junction-to-Case | $\mathrm{R}_{\theta \mathrm{JC}}$ | 3.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| - Junction-to-Ambient | $\mathrm{R}_{\theta \mathrm{AJA}}$ | 88 |  |
| - Junction-to-Ambient (Note 2) | $\mathrm{R}_{\theta \mathrm{JA}}$ | 80 |  |
| Maximum Lead Temperature for Soldering Purposes (Note 3) | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted; Electricals apply in both directions)

| Characteristic |  | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |  |
| Peak Repetitive Blocking Current ( $\mathrm{V}_{\mathrm{D}}=$ Rated $\mathrm{V}_{\mathrm{DRM}}, \mathrm{V}_{\mathrm{RRM}}$; Gate Open) | $\begin{aligned} & \mathrm{T}_{J}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{J}=110^{\circ} \mathrm{C} \end{aligned}$ | IDRM, IRRM | - | - | $\begin{gathered} 0.01 \\ 2.0 \end{gathered}$ | mA |

## ON CHARACTERISTICS

| Peak On-State Voltage (Note 4) - ( $\mathrm{I}_{\text {TM }}= \pm 6.0 \mathrm{~A}$ ) | $\mathrm{V}_{\text {TM }}$ | - | 1.3 | 1.6 | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ```Gate Trigger Current (Continuous dc) ( \(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega\) ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)``` | $\mathrm{I}_{\text {GT }}$ |  | $\begin{aligned} & 1.8 \\ & 2.1 \\ & 2.4 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & 10 \end{aligned}$ | mA |
| ```Gate Trigger Voltage (Continuous dc) ( \(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega\) ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-) MT2(-), G(+)``` | $\mathrm{V}_{\mathrm{GT}}$ | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 0.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 0.62 \\ & 0.57 \\ & 0.65 \\ & 0.74 \end{aligned}$ | $\begin{aligned} & 1.3 \\ & 1.3 \\ & 1.3 \\ & 1.3 \end{aligned}$ | V |
| Gate Non-Trigger Voltage (Continuous dc) - $\left(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~T}_{\mathrm{J}}=110^{\circ} \mathrm{C}\right)$ All Four Quadrants | $\mathrm{V}_{\mathrm{GD}}$ | 0.1 | 0.4 | - | V |
| Holding Current ( $\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}$, Gate Open, Initiating Current $= \pm 200 \mathrm{~mA}$ ) | $\mathrm{I}_{\mathrm{H}}$ | - | 1.5 | 15 | mA |
| $\begin{array}{cc} \hline \text { Latching Current } & \\ \text { MT2(+), G(+) } & \left(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{I}_{\mathrm{G}}=5.0 \mathrm{~mA}\right) \\ \text { MT2(+), G(-) } & \left(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{I}_{\mathrm{G}}=5.0 \mathrm{~mA}\right) \\ \text { MT2(-), G(-) } & \left(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{I}_{\mathrm{G}}=5.0 \mathrm{~mA}\right) \\ \text { MT2(-), G(+) } & \left(\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{I}_{\mathrm{G}}=10 \mathrm{~mA}\right) \end{array}$ | L | - | $\begin{gathered} 1.75 \\ 5.2 \\ 2.1 \\ 2.2 \end{gathered}$ | 10 10 10 10 | mA |

DYNAMIC CHARACTERISTICS

| Rate of Change of Commutating Current $\begin{aligned} & \left(\mathrm{V}_{\mathrm{D}}=200 \mathrm{~V}, \mathrm{I}_{\mathrm{TM}}=1.8 \mathrm{~A}, \text { Commutating dv} / \mathrm{dt}=1.0 \mathrm{~V} / \mathrm{usec},\right. \\ & \mathrm{T}_{J}=110^{\circ} \mathrm{C}, \mathrm{f}=250 \mathrm{~Hz}, \mathrm{CL}=5.0 \mu \mathrm{fd}, \mathrm{LL}=80 \mathrm{mH}, \mathrm{RS}=56 \Omega \text {, } \\ & \mathrm{CS}=0.03 \mu \mathrm{fd}) \text { With snubber see Figure } 11 \end{aligned}$ | di/dt(c) | - | 3.0 | - | A/ms |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Critical Rate of Rise of Off-State Voltage ( $\mathrm{V}_{\mathrm{D}}=0.67 \mathrm{X}$ Rated $\mathrm{V}_{\mathrm{DRM}}$, Exponential Waveform, Gate Open, $\mathrm{T}_{J}=110^{\circ} \mathrm{C}$ ) | dv/dt | 20 | - | - | V/us |

2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.
3. $1 / 8^{\prime \prime}$ from case for 10 seconds.
4. Pulse Test: Pulse Width $\leq 2.0 \mathrm{msec}$, Duty Cycle $\leq 2 \%$.

ORDERING INFORMATION

| Device | Package Type | Package | Shipping ${ }^{\dagger}$ |
| :--- | :---: | :---: | :---: |
| MAC4DHM-001 | DPAK-3 | 369 D | 75 Units / Rail |
| MAC4DHM-001G | DPAK-3 <br> (Pb-Free) | 369 D | 75 Units / Rail |
| MAC4DHMT4 | DPAK | 369 C | $2500 /$ Tape \& Reel |
| MAC4DHMT4G | DPAK <br> (Pb-Free) | 369 C | $2500 /$ Tape \& Reel |

[^0] Specifications Brochure, BRD8011/D.

## MAC4DHM

## Voltage Current Characteristic of Triacs

(Bidirectional Device)

| Symbol | Parameter |
| :--- | :--- |
| $\mathrm{V}_{\text {DRM }}$ | Peak Repetitive Forward Off-State Voltage |
| $\mathrm{I}_{\text {DRM }}$ | Peak Forward Blocking Current |
| $\mathrm{V}_{\text {RRM }}$ | Peak Repetitive Reverse Off-State Voltage |
| $\mathrm{I}_{\text {RRM }}$ | Peak Reverse Blocking Current |
| $\mathrm{V}_{\text {TM }}$ | Maximum On-State Voltage |
| $\mathrm{I}_{\mathrm{H}}$ | Holding Current |



Quadrant Definitions for a Triac


All polarities are referenced to MT1.
With in-phase signals (using standard AC lines) quadrants I and III are used.

## MAC4DHM



Figure 1. RMS Current Derating


Figure 3. On-State Characteristics


Figure 2. On-State Power Dissipation


Figure 4. Transient Thermal Response


Figure 6. Typical Gate Trigger Voltage versus Junction Temperature


Figure 7. Typical Holding Current versus Junction Temperature


Figure 9. Minimum Exponential Static dv/dt versus Gate-MT1 Resistance


Figure 8. Typical Latching Current versus Junction Temperature


Figure 10. Typical Critical Rate of Rise of Commutating Voltage


Note: Component values are for verification of rated $(\mathrm{di} / \mathrm{dt})_{c}$. See AN1048 for additional information.
Figure 11. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)c

## MAC4DHM

## PACKAGE DIMENSIONS

DPAK<br>CASE 369C<br>ISSUE O


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.235 | 0.245 | 5.97 | 6.22 |
| B | 0.250 | 0.265 | 6.35 | 6.73 |
| C | 0.086 | 0.094 | 2.19 | 2.38 |
| D | 0.027 | 0.035 | 0.69 | 0.88 |
| E | 0.018 | 0.023 | 0.46 | 0.58 |
| F | 0.037 | 0.045 | 0.94 | 1.14 |
| G | 0.180 BSC |  | 4.58 BSC |  |
| H | 0.034 | 0.040 | 0.87 | 1.01 |
| J | 0.018 | 0.023 | 0.46 | 0.58 |
| K | 0.102 | 0.114 | 2.60 | 2.89 |
| L | 0.090 BSC |  | 2.29 BSC |  |
| R | 0.180 | 0.215 | 4.57 | 5.45 |
| S | 0.025 | 0.040 | 0.63 | 1.01 |
| U | 0.020 | --- | 0.51 | --- |
| V | 0.035 | 0.050 | 0.89 | 1.27 |
| Z | 0.155 | --- | 3.93 | --- |

STYLE 6:
PIN 1. MT1
2. MT2
3. GATE
3. MT2

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

## MAC4DHM

## PACKAGE DIMENSIONS

DPAK-3
CASE 369D-01
ISSUE B


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
CONTROLLING DIMENSION: INCH


| DIM | INCHES |  | MILLIMETERS |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |
| A | 0.235 | 0.245 | 5.97 | 6.35 |  |  |
| B | 0.250 | 0.265 | 6.35 | 6.73 |  |  |
| C | 0.086 | 0.094 | 2.19 | 2.38 |  |  |
| D | 0.027 | 0.035 | 0.69 | 0.88 |  |  |
| E | 0.018 | 0.023 | 0.46 | 0.58 |  |  |
| F | 0.037 | 0.045 | 0.94 | 1.14 |  |  |
| G | 0.090 |  | BSC | 2.29 |  | BSC |
| H | 0.034 | 0.040 | 0.87 | 1.01 |  |  |
| J | 0.018 | 0.023 | 0.46 | 0.58 |  |  |
| K | 0.350 | 0.380 | 8.89 | 9.65 |  |  |
| R | 0.180 | 0.215 | 4.45 | 5.45 |  |  |
| S | 0.025 | 0.040 | 0.63 | 1.01 |  |  |
| V | 0.035 | 0.050 | 0.89 | 1.27 |  |  |
| Z | 0.155 | --- | 3.93 | --- |  |  |

STYLE 6:
PIN 1. MT1
2. MT2
3. GATE
4. MT2

[^1]
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## LITERATURE FULFILLMENT

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[^0]:    $\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging

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